

DATA SHEET

TDA8772; TDA8772A
Triple 8-bit video digital-to-analog
converter

Product specification
Supersedes data of May 1994
File under Integrated Circuits, IC02

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Philips Semiconductors



PHILIPS

Triple 8-bit video digital-to-analog converter

TDA8772; TDA8772A

FEATURES

- 8-bit resolution
- Sampling rate up to
35 MHz for TDA8772H/3, TDA8772AH/3
85 MHz for TDA8772H/8, TDA8772AH/8
- Internal reference voltage regulator
- No deglitching circuit required
- SYNC, BLANK control inputs
- 3 independent clock inputs (one per DAC)
- 1 V output voltage range
- 75 Ω output load
- TDA8772A has BLANK control input on the GREEN channel only while TDA8772 has it on the 3 channels
- Single 5 V power supply
- 44-pin QFP package.

GENERAL DESCRIPTION

The TDA8772, TDA8772A are triple 8-bit video digital-to-analog converters (DACs). They convert the digital input signals into analog voltage outputs at a maximum conversion rate of 35 MHz (TDA8772H/3, TDA8772AH/3) and 85 MHz (TDA8772H/8, TDA8772AH/8).

The DACs are based on resistor-string architecture with integrated output buffers. The output voltage range is determined by a built-in reference source.

The devices are fabricated in a 5 V CMOS process that ensures high functionality with low power dissipation.

APPLICATIONS

- General purpose high-speed digital-to-analog conversion
- Digital TV
- Graphic display
- Desktop video processing.

ORDERING INFORMATION

| TYPE NUMBER | PACKAGE | | | | SAMPLING FREQUENCY |
|-------------|---------|--------------|----------|---------|--------------------|
| | PINS | PIN POSITION | MATERIAL | CODE | |
| TDA8772H/3 | 44 | QFP44 | plastic | SOT307B | 35 MHz |
| TDA8772AH/3 | 44 | QFP44 | plastic | SOT307B | 35 MHz |
| TDA8772H/8 | 44 | QFP44 | plastic | SOT307B | 85 MHz |
| TDA8772AH/8 | 44 | QFP44 | plastic | SOT307B | 85 MHz |

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QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------|---|--|------|------------|------------|------|
| V_{DDA} | analog supply voltage | | 4.5 | 5.0 | 5.5 | V |
| V_{DDD} | digital supply voltage | | 4.5 | 5.0 | 5.5 | V |
| I_{DDA} | analog supply current | $R_L = 75 \Omega$; note 1 | 40 | 65 | 100 | mA |
| I_{DDD} | digital supply current TDA8772H/3, TDA8772AH/3 TDA8772H/8, TDA8772AH/8 | | — | 7 | 16 | mA |
| | | | — | 16 | 27 | mA |
| INL | integral non-linearity ² | $f_{clk} = 35 \text{ MHz}$; ramp input | — | ± 0.5 | ± 1 | LSB |
| | | $f_{clk} = 85 \text{ MHz}$; ramp input | — | ± 0.75 | ± 1.2 | LSB |
| DNL | differential non-linearity | $f_{clk} = 35 \text{ MHz}$; ramp input | — | ± 0.25 | ± 0.5 | LSB |
| | | $f_{clk} = 85 \text{ MHz}$; ramp input | - | ± 0.5 | ± 0.75 | LSB |
| $f_{clk(max)}$ | maximum clock frequency TDA8772H/3, TDA8772AH/3 TDA8772H/8, TDA8772AH/8 | | 35 | — | — | MHz |
| | | | 85 | — | — | MHz |
| P_{tot} | total power dissipation TDA8772H/3, TDA8772AH/3 TDA8772H/8, TDA8772AH/8 | note 1 | 180 | 360 | 640 | mW |
| | | $R_L = 75 \Omega$; $f_{clk} = 35 \text{ MHz}$ | 180 | 405 | 700 | mW |
| | | $R_L = 75 \Omega$; $f_{clk} = 85 \text{ MHz}$ | | | | |

Note

1. Minimum and maximum data of current and power consumption are measured in worse case conditions: for minimum data, all digital inputs are at logic level 0 while for maximum data, all digital inputs are at logic level 1.

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BLOCK DIAGRAMS

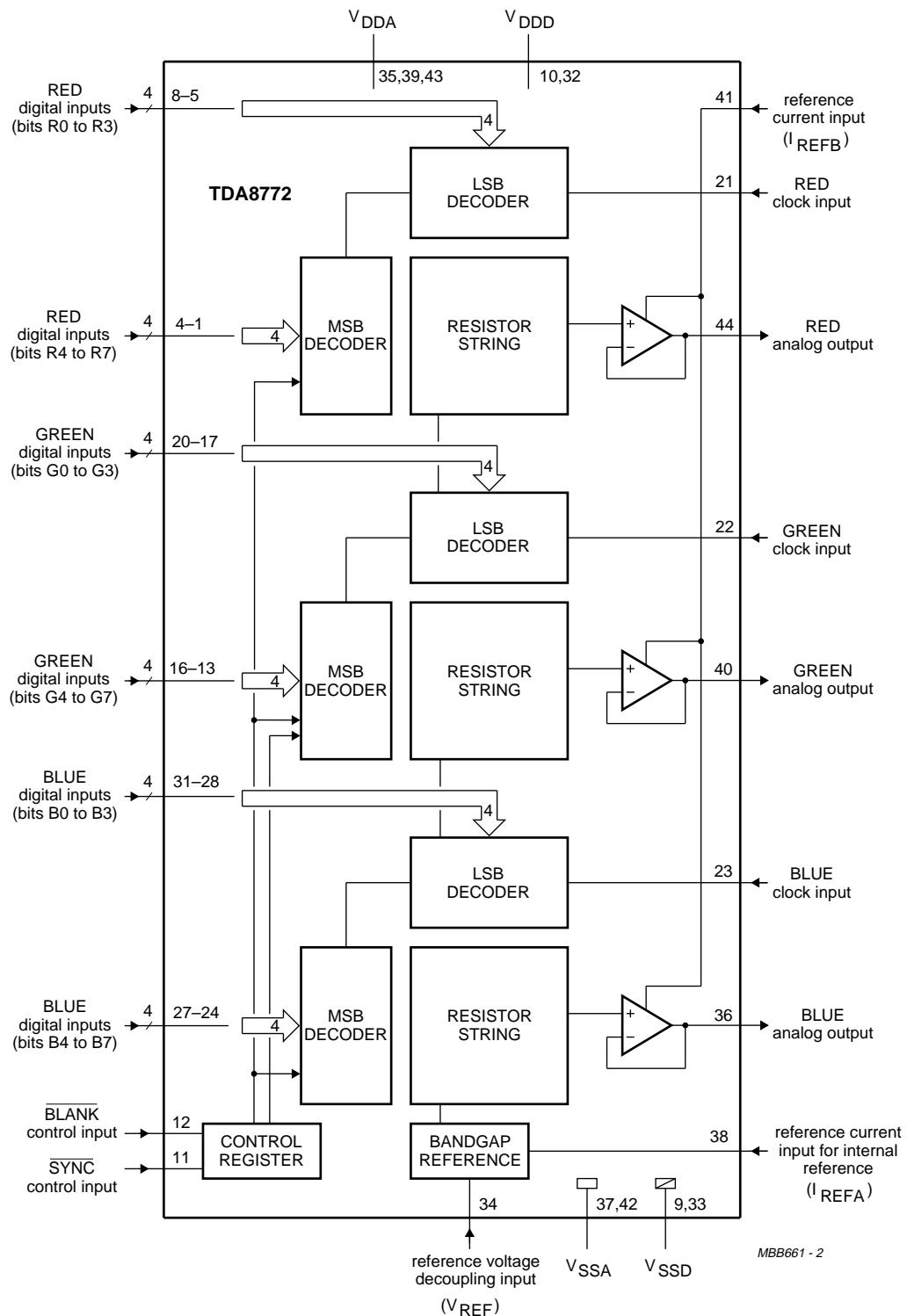


Fig.1 Block diagram for TDA8772.

Triple 8-bit video digital-to-analog converter

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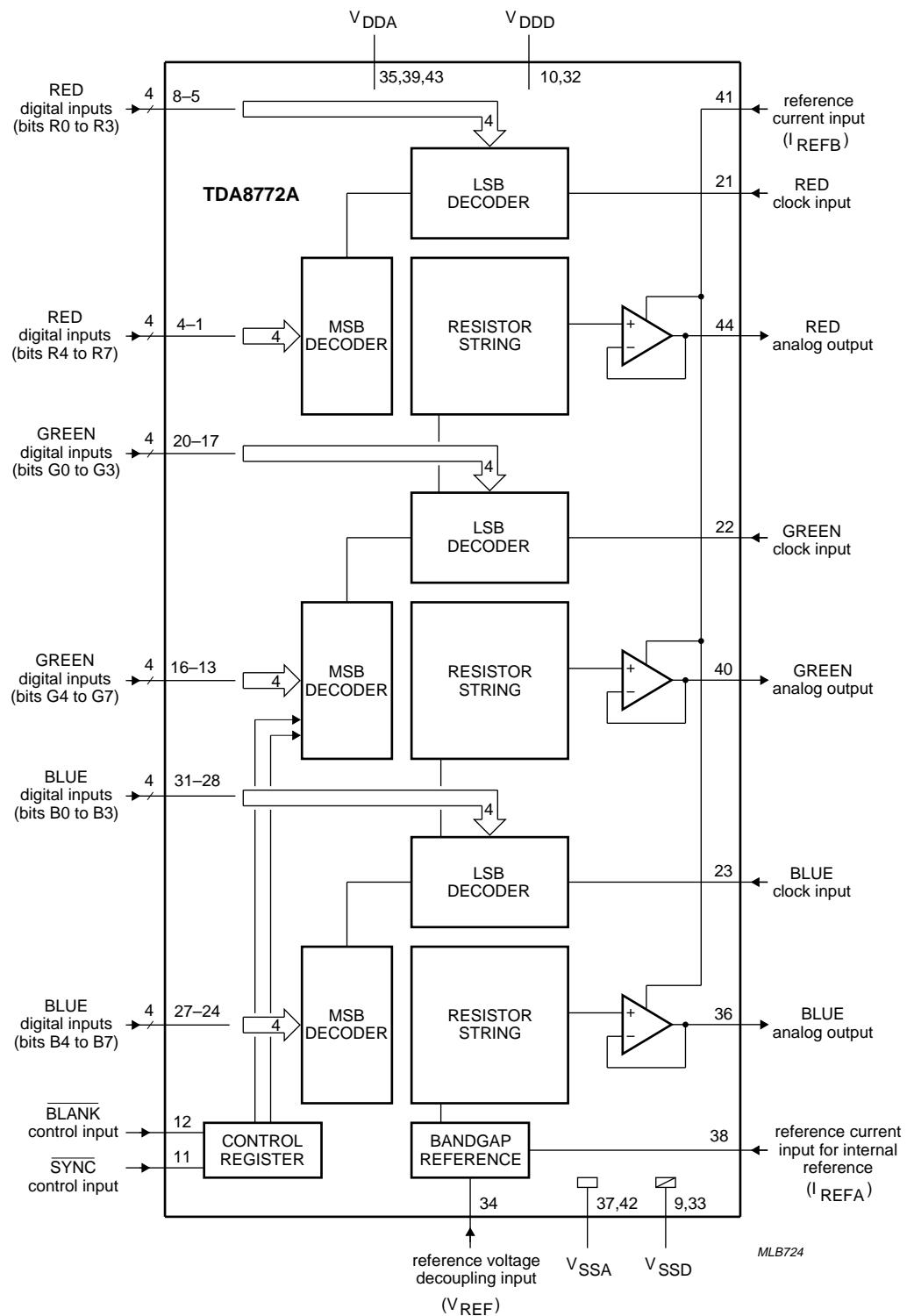


Fig.2 Block diagram for TDA8772A.

Triple 8-bit video digital-to-analog converter

TDA8772; TDA8772A

PINNING

| SYMBOL | PIN | DESCRIPTION |
|-------------------|-----|---|
| R7 | 1 | RED digital input data; bit 7 (MSB) |
| R6 | 2 | RED digital input data; bit 6 |
| R5 | 3 | RED digital input data; bit 5 |
| R4 | 4 | RED digital input data; bit 4 |
| R3 | 5 | RED digital input data; bit 3 |
| R2 | 6 | RED digital input data; bit 2 |
| R1 | 7 | RED digital input data; bit 1 |
| R0 | 8 | RED digital input data; bit 0 (LSB) |
| V _{SSD1} | 9 | digital supply ground 1 |
| V _{DDD1} | 10 | digital supply voltage 1 |
| SYNC | 11 | composite sync control input; for GREEN channel only (active LOW) |
| BLANK | 12 | composite blank control input (active LOW) |
| G7 | 13 | GREEN digital input data; bit 7 (MSB) |
| G6 | 14 | GREEN digital input data; bit 6 |
| G5 | 15 | GREEN digital input data; bit 5 |
| G4 | 16 | GREEN digital input data; bit 4 |
| G3 | 17 | GREEN digital input data; bit 3 |
| G2 | 18 | GREEN digital input data; bit 2 |
| G1 | 19 | GREEN digital input data; bit 1 |
| G0 | 20 | GREEN digital input data; bit 0 (LSB) |
| CLKR | 21 | RED clock input |
| CLKG | 22 | GREEN clock input |
| CLKB | 23 | BLUE clock input |
| B7 | 24 | BLUE digital input data; bit 7 (MSB) |
| B6 | 25 | BLUE digital input data; bit 6 |
| B5 | 26 | BLUE digital input data; bit 5 |
| B4 | 27 | BLUE digital input data; bit 4 |
| B3 | 28 | BLUE digital input data; bit 3 |
| B2 | 29 | BLUE digital input data; bit 2 |
| B1 | 30 | BLUE digital input data; bit 1 |
| B0 | 31 | BLUE digital input data; bit 0 (LSB) |
| V _{DDD2} | 32 | digital supply voltage 2 |
| V _{SSD2} | 33 | digital supply ground 2 |
| V _{REF} | 34 | decoupling input for reference voltage |
| V _{DDA1} | 35 | analog supply voltage 1 |
| OUTB | 36 | BLUE analog output |
| V _{SSA1} | 37 | analog supply ground 1 |
| I _{REFA} | 38 | reference current input for internal reference |
| V _{DDA2} | 39 | analog supply voltage 2 |
| OUTG | 40 | GREEN analog output |

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| SYMBOL | PIN | DESCRIPTION |
|------------|-----|--|
| I_{REFB} | 41 | reference current input for output buffers |
| V_{SSA2} | 42 | analog supply ground 2 |
| V_{DDA3} | 43 | analog supply voltage 3 |
| OUTR | 44 | RED analog output |

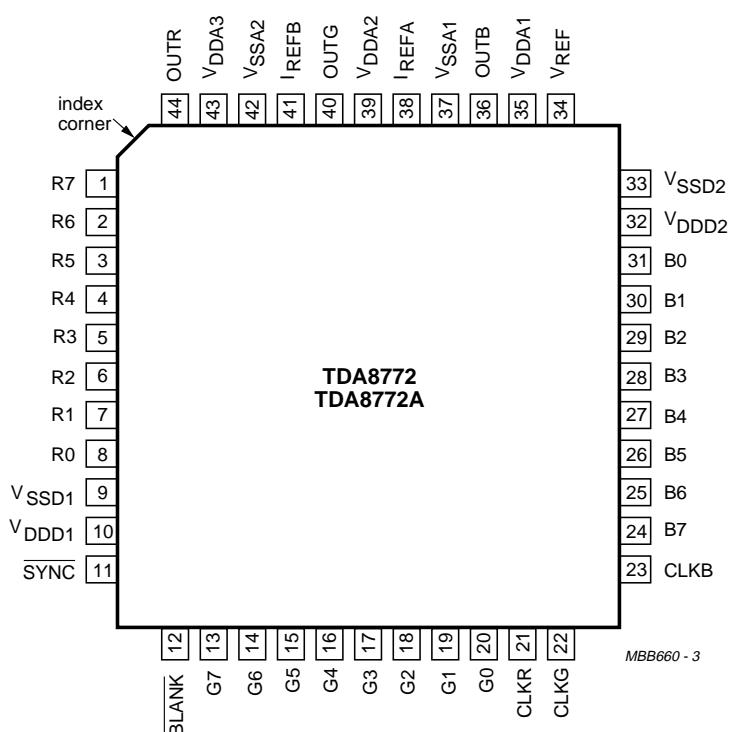


Fig.3 Pin configuration.

Triple 8-bit video digital-to-analog converter

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LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC134).

| SYMBOL | PARAMETER | MIN. | MAX. | UNIT |
|-----------------|---|------|------|------|
| V_{DDA} | analog supply voltage | -0.5 | +6.5 | V |
| V_{DDD} | digital supply voltage | -0.5 | +6.5 | V |
| ΔV_{DD} | supply voltage difference between V_{DDA} and V_{DDD} | -1.0 | +1.0 | V |
| T_{stg} | storage temperature | -55 | +150 | °C |
| T_{amb} | operating ambient temperature | 0 | +70 | °C |
| T_j | junction temperature | - | +125 | °C |

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | VALUE | UNIT |
|---------------|---|-------|------|
| $R_{th\ j-a}$ | thermal resistance from junction to ambient in free air | 75 | K/W |

HANDLING

Inputs and outputs are protected against electrostatic discharges in normal handling. However, to be totally safe, it is desirable to take normal precautions appropriate to handling integrated circuits.

Triple 8-bit video digital-to-analog converter

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CHARACTERISTICS

TDA8772H/3, TDA8772AH/3 operating at 35 MHz and TDA8772H/8, TDA8772AH/8 operating at 85 MHz unless otherwise specified.

$V_{DDA} = V_{DDD} = 4.5$ V to 5.5 V; V_{SSA} and V_{SSD} shorted together; $V_{DDA} - V_{DDD} = -0.5$ V to +0.5 V; $T_{amb} = 0$ to +70 °C; typical values measured at $V_{DDA} = V_{DDD} = 5$ V and $T_{amb} = 25$ °C; unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|---|---|----------------------------|-----------------|------|-----------------|------|
| Supply | | | | | | |
| V_{DDA} | analog supply voltage | | 4.5 | 5.0 | 5.5 | V |
| V_{DDD} | digital supply voltage | | 4.5 | 5.0 | 5.5 | V |
| I_{DDA} | analog supply current | $R_L = 75 \Omega$; note 1 | 40 | 65 | 100 | mA |
| I_{DDD} | digital supply current | | — | 7 | 16 | mA |
| | TDA8772H/3, TDA8772AH/3 | | — | 16 | 27 | mA |
| | TDA8772H/8, TDA8772AH/8 | | | | | |
| Inputs | | | | | | |
| CLOCK INPUTS (PINS 21, 22 AND 23) | | | | | | |
| V_{IL} | LOW level input voltage | | $V_{SSD} - 0.5$ | — | 0.8 | V |
| V_{IH} | HIGH level input voltage | | 2.0 | — | $V_{DDD} + 0.5$ | V |
| BLANK, SYNC INPUTS (PINS 12 AND 11; ACTIVE LOW) | | | | | | |
| V_{IL} | LOW level input voltage | | $V_{SSD} - 0.5$ | — | 0.8 | V |
| V_{IH} | HIGH level input voltage | | 2.0 | — | $V_{DDD} + 0.5$ | V |
| R, G, B DIGITAL INPUTS (PINS 1 TO 8, 13 TO 20 AND 24 TO 31) | | | | | | |
| V_{IL} | LOW level input voltage | | $V_{SSD} - 0.5$ | — | 0.8 | V |
| V_{IH} | HIGH level input voltage | | 2.0 | — | $V_{DDD} + 0.5$ | V |
| I_{REFA} INTERNAL REFERENCE SUPPLY CURRENT (PIN 38) | | | | | | |
| I_I | input current | | — | 0.17 | 0.25 | mA |
| I_{REFB} OUTPUT BUFFER SUPPLY CURRENT (PIN 41) | | | | | | |
| I_I | input current | | — | 0.5 | 0.7 | mA |
| Timing ($C_L = 25 \text{ pF}$; $R_L = 75 \Omega$); see Fig.4 | | | | | | |
| $f_{clk(max)}$ | maximum clock frequency TDA8772H/3, TDA8772AH/3 TDA8772H/8, TDA8772AH/8 | | 35 | — | — | MHz |
| | | | 85 | — | — | MHz |
| t_{CPH} | clock pulse width HIGH | | 5 | — | — | ns |
| t_{CPL} | clock pulse width LOW | | 5 | — | — | ns |
| t_r | clock rise time TDA8772H/3, TDA8772AH/3 TDA8772H/8, TDA8772AH/8 | | — | — | 5 | ns |
| | | | — | — | 3 | ns |
| t_f | clock fall time TDA8772H/3, TDA8772AH/3 TDA8772H/8, TDA8772AH/8 | | — | — | 5 | ns |
| | | | — | — | 3 | ns |
| $t_{SU;DAT}$ | input data set-up time | | 4 | — | — | ns |
| $t_{HD;DAT}$ | input data hold time | | 2.5 | — | — | ns |

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| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|--|---------------------------------|---|-------|------------|------------|----------|
| Voltage reference (pin 34, referenced to V_{SSA}) | | | | | | |
| V_{REF} | output reference voltage | | 1.180 | 1.242 | 1.305 | V |
| Outputs | | | | | | |
| OUTB, OUTR, OUTG ANALOG OUTPUTS (PINS 36, 44 AND 40, REFERENCED TO V_{SSA}) FOR 75 Ω LOAD; see Tables 1 and 2 | | | | | | |
| FSR | full-scale output voltage range | | 0.9 | 1.0 | 1.1 | V |
| V_{os} | offset of analog voltage output | | 0.75 | 0.83 | 0.95 | V |
| V_{OUTmax} | maximum output voltage | data inputs = logic 1; note 2 | 1.65 | 1.83 | 2.05 | V |
| V_{OUTmin} | minimum output voltage | data inputs = logic 0; note 2 | 0.75 | 0.83 | 0.95 | V |
| THD | total harmonic distortion | $f_i = 4.43$ MHz; $f_{clk} = 35$ MHz | – | –45 | – | dB |
| | | $f_i = 4.43$ MHz; $f_{clk} = 85$ MHz | – | –43 | – | dB |
| Z_L | output load impedance | | 60 | 75 | 90 | Ω |
| Transfer function | | | | | | |
| INL | integral non-linearity | $f_{clk} = 35$ MHz; ramp input | – | ± 0.5 | ± 1 | LSB |
| | | $f_{clk} = 85$ MHz; ramp input | – | ± 0.75 | ± 1.2 | LSB |
| DNL | differential non-linearity | $f_{clk} = 35$ MHz; ramp input | – | ± 0.25 | ± 0.5 | LSB |
| | | $f_{clk} = 85$ MHz; ramp input | – | ± 0.5 | ± 0.75 | LSB |
| α_{CT} | crosstalk DAC to DAC | | –45 | – | – | dB |
| | DAC to DAC matching | | – | 1.0 | 2.0 | % |
| Switching characteristics (for 75 Ω output load); see Fig.5 | | | | | | |
| t_d | input to 50% output delay time | full-scale change | – | 10 | – | ns |
| t_{s1} | settling time | 10% to 90% full-scale change | – | 6 | – | ns |
| t_{s2} | settling time | to ± 1 LSB | – | 30 | – | ns |
| Output transients (glitches) | | | | | | |
| V_g | area for 1 LSB change | | – | 1 | – | LSB.ns |

Notes

1. Minimum and maximum data of current and power consumption are measured in worse case conditions: for minimum data, all digital inputs are at logic level 0 while for maximum data, all digital inputs are at logic level 1.
2. V_{OUT} is directly proportional to V_{REF} .

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Table 1 Input coding and DAC output voltages (typical values)

| BINARY INPUT DATA (SYNC = BLANK = 0) | CODE | DAC OUTPUT VOLTAGES (V) OUTB, OUTR, OUTG $R_L = 75 \Omega$ |
|---|------|--|
| 0000 0000 | 0 | 0.830 |
| 0000 0001 | 1 | 0.834 |
| | . | . |
| 1000 0000 | 128 | 1.330 |
| | . | . |
| 1111 1110 | 254 | 1.826 |
| 1111 1111 | 255 | 1.830 |

Table 2 Input coding and DAC output voltages (typical values)

| BINARY INPUT DATA | SYNC (PIN 11) | BLANK (PIN 12) | DAC OUTPUT VOLTAGES (V) | | |
|-------------------|------------------|-------------------|-------------------------|------------------------------------|-------------------------------------|
| | | | OUTG (PIN 40) | OUTR/B (PINS 44, 46) TDA8772 | OUTR/B (PINS 44, 46) TDA8772A |
| | x | 1 | see Table 1 | see Table 1 | see Table 1 |
| | 1 | 0 | 0.830 | 0.830 | |
| | 0 | 0 | 0.440 | | |

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TIMING

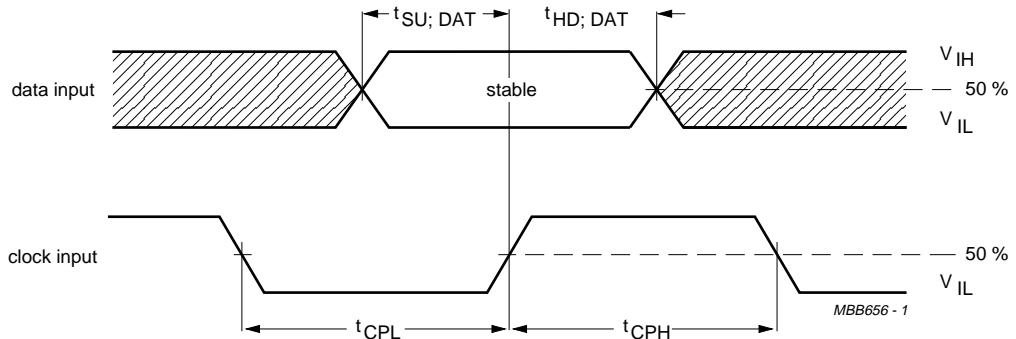


Fig.4 Input timing.

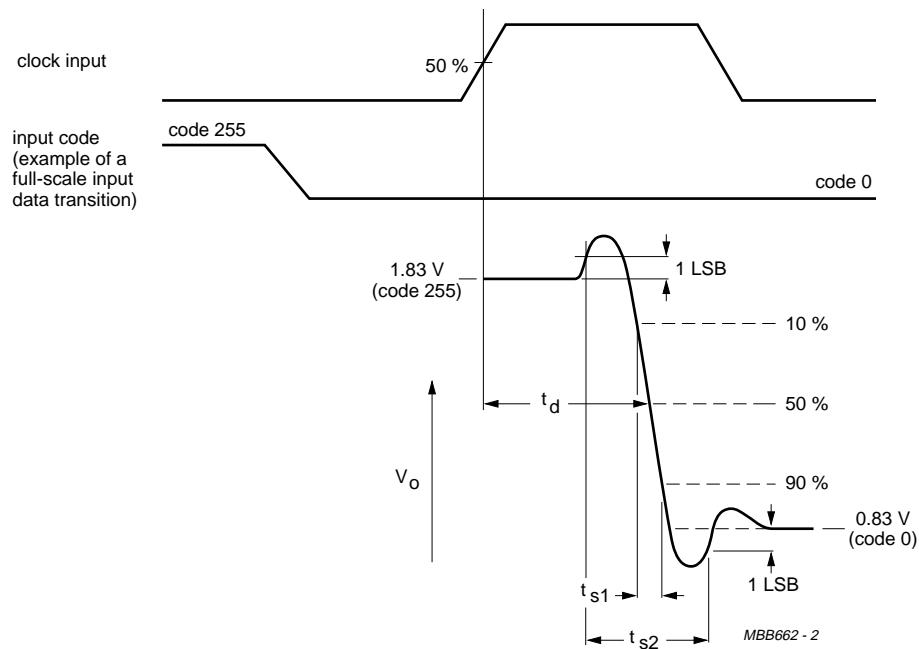
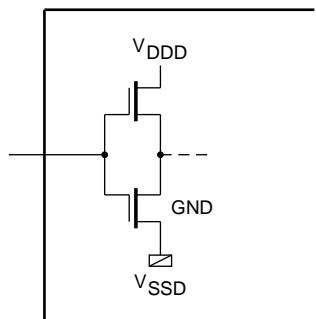


Fig.5 Switching timing.

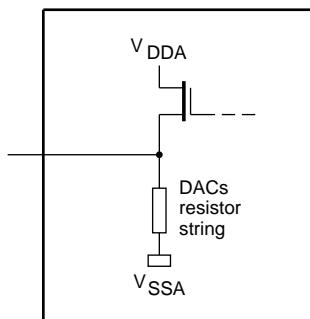
Triple 8-bit video digital-to-analog converter

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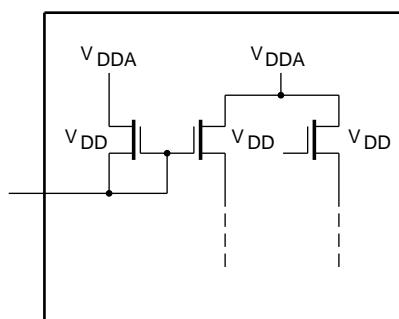
INTERNAL CIRCUITRY



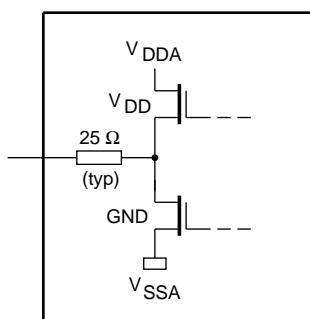
(a)



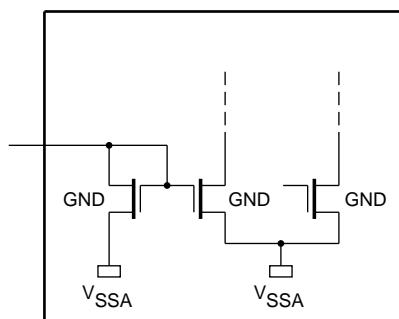
(b)



(c)



(d)



(e)

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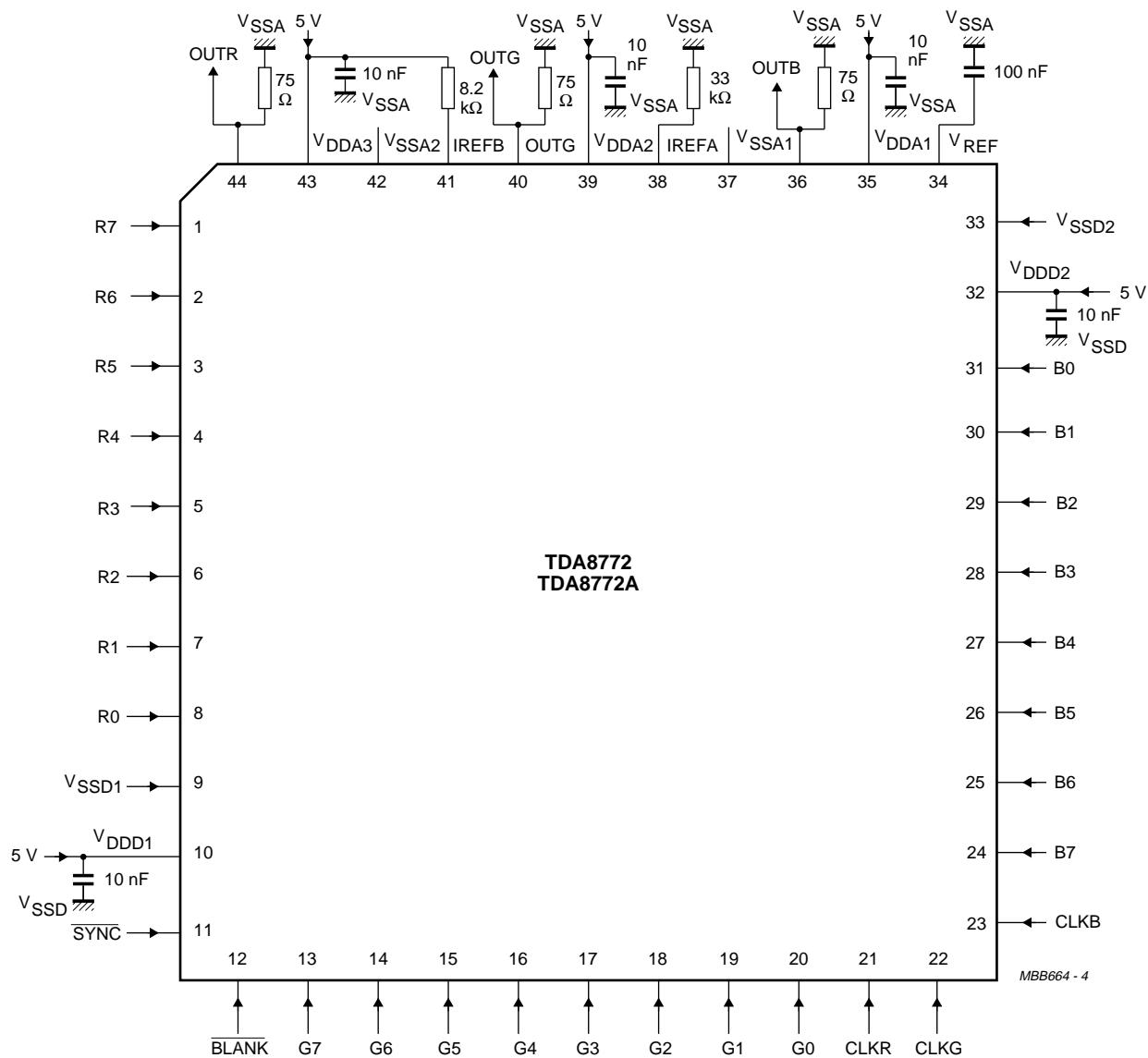
- (a) Digital inputs; pins 1 to 8 and 11 to 31.
- (b) V_{REF} ; pin 34.
- (c) I_{REF_A} ; pin 38.
- (d) OUT_R , G , B ; pins 44, 40 and 36.
- (e) I_{REF_B} ; pin 41.

Fig.6 Internal circuitry.

Triple 8-bit video digital-to-analog converter

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APPLICATION INFORMATION



Analog and digital supplies should be separated and decoupled.

Supplies are not connected internally.

All ground pins must be connected. One ground plane is preferred although it depends on the application.

See Fig.8 for example of anti-aliasing filter.

Fig.7 Application diagram.

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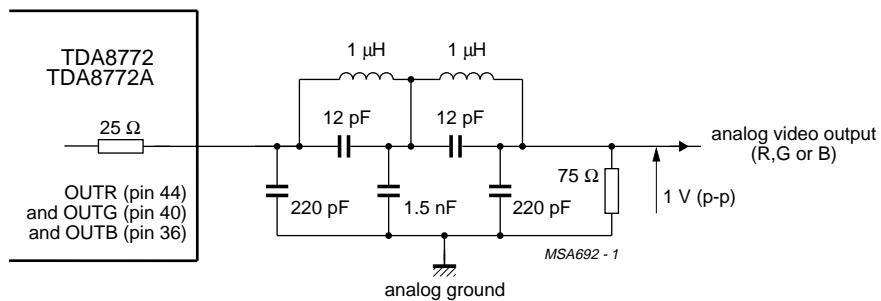


Fig.8 Example of anti-aliasing filter for 1 V output swing.

Characteristics of Fig.9

- Order 5; adapted CHEBYSHEV
- Ripple $\rho \geq 0.6\text{ dB}$
- f at $-3\text{ dB} = 6.5\text{ MHz}$
- $f_{\text{NOTCH}} = 46\text{ MHz}$.

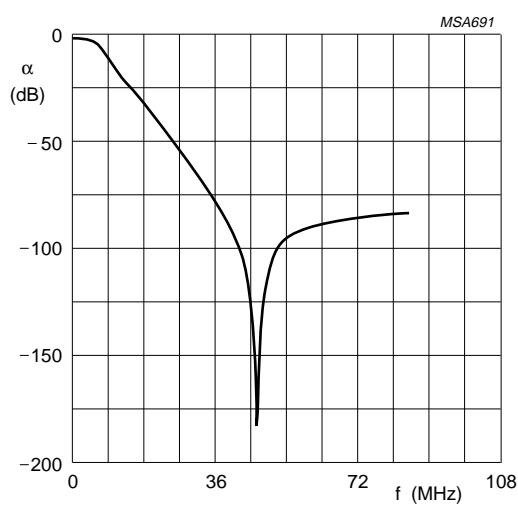


Fig.9 Frequency response for filter shown in Fig.8.

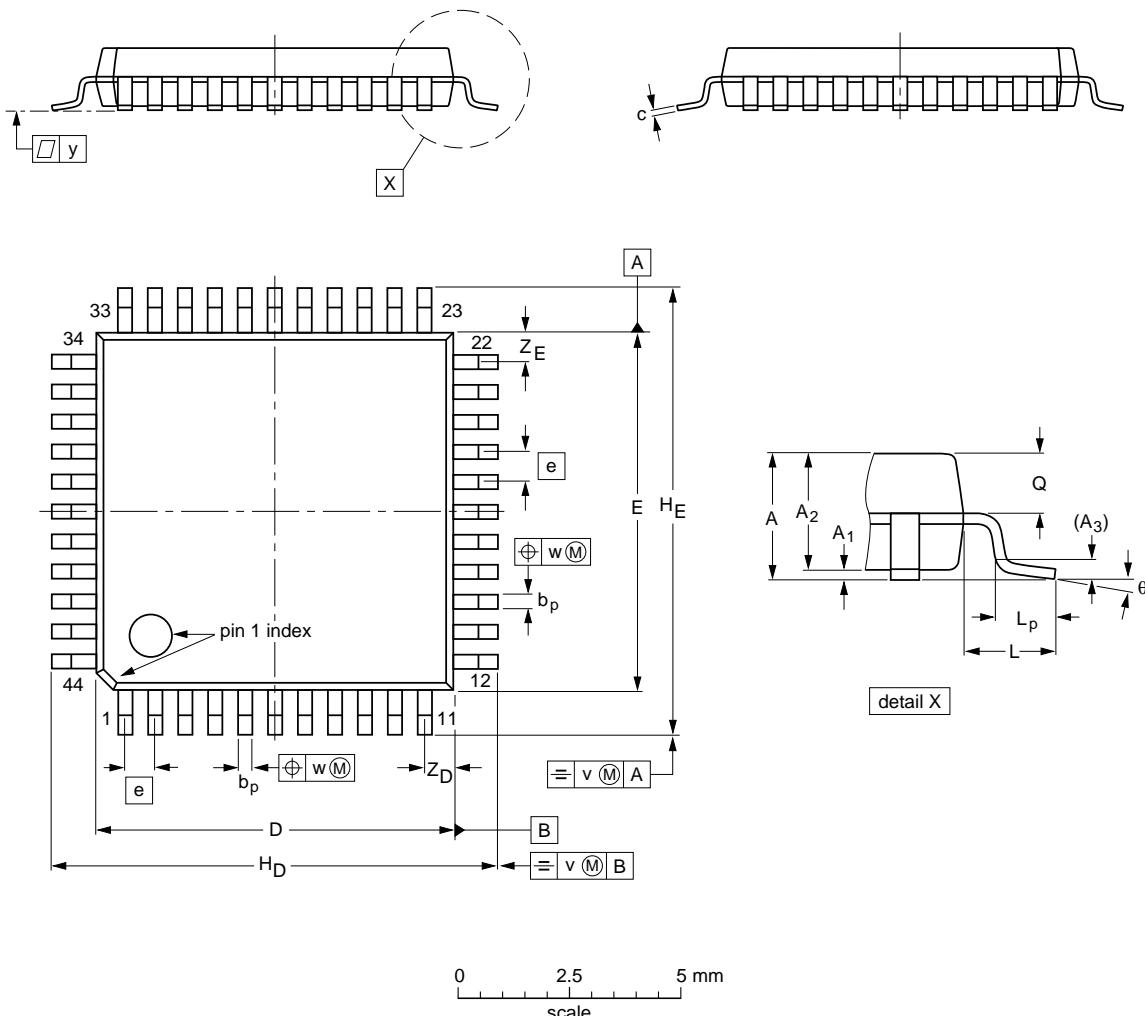
Triple 8-bit video digital-to-analog converter

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PACKAGE OUTLINE

QFP44: plastic quad flat package; 44 leads (lead length 1.3 mm); body 10 x 10 x 1.75 mm

SOT307-2



DIMENSIONS (mm are the original dimensions)

| UNIT | A max. | A ₁ | A ₂ | A ₃ | b _p | c | D ⁽¹⁾ | E ⁽¹⁾ | e | H _D | H _E | L | L _p | Q | v | w | y | Z _D ⁽¹⁾ | Z _E ⁽¹⁾ | θ |
|------|--------------|----------------|----------------|----------------|----------------|--------------|------------------|------------------|-----|----------------|----------------|-----|----------------|--------------|------|------|-----|-------------------------------|-------------------------------|-----------|
| mm | 2.10 0.05 | 0.25 1.65 | 1.85 0.25 | 0.25 | 0.40 0.20 | 0.25 0.14 | 10.1 9.9 | 10.1 9.9 | 0.8 | 12.9 12.3 | 12.9 12.3 | 1.3 | 0.95 0.55 | 0.85 0.75 | 0.15 | 0.15 | 0.1 | 1.2 0.8 | 1.2 0.8 | 10° 0° |

Note

- Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|-------|------|--|------------------------|----------------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT307-2 | | | | | | 92-11-17 95-02-04 |

Triple 8-bit video digital-to-analog converter

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SOLDERING

Plastic quad flat packages

BY WAVE

During placement and before soldering, the component must be fixed with a droplet of adhesive. After curing the adhesive, the component can be soldered. The adhesive can be applied by screen printing, pin transfer or syringe dispensing.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder bath is 10 s, if allowed to cool to less than 150 °C within 6 s. Typical dwell time is 4 s at 250 °C.

A modified wave soldering technique is recommended using two solder waves (dual-wave), in which a turbulent wave with high upward pressure is followed by a smooth laminar wave. Using a mildly-activated flux eliminates the need for removal of corrosive residues in most applications.

BY SOLDER PASTE REFLOW

Reflow soldering requires the solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the substrate by screen printing, stencilling or pressure-syringe dispensing before device placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt, infrared, and vapour-phase reflow. Dwell times vary between 50 and 300 s according to method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 min at 45 °C.

REPAIRING SOLDERED JOINTS (BY HAND-HELD SOLDERING IRON OR PULSE-HEATED SOLDER TOOL)

Fix the component by first soldering two, diagonally opposite, end pins. Apply the heating tool to the flat part of the pin only. Contact time must be limited to 10 s at up to 300 °C. When using proper tools, all other pins can be soldered in one operation within 2 to 5 s at between 270 and 320 °C. (Pulse-heated soldering is not recommended for SO packages.)

For pulse-heated solder tool (resistance) soldering of VSO packages, solder is applied to the substrate by dipping or by an extra thick tin/lead plating before package placement.

DEFINITIONS

| Data sheet status | |
|---|---|
| Objective specification | This data sheet contains target or goal specifications for product development. |
| Preliminary specification | This data sheet contains preliminary data; supplementary data may be published later. |
| Product specification | This data sheet contains final product specifications. |
| Limiting values | |
| Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability. | |
| Application information | |
| Where application information is given, it is advisory and does not form part of the specification. | |

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.